g	GE Energy			Functio	onal Testing Spe	ecification	
Parts & Repair Services Louisville, KY				LOU-GENEVA-IS200EDGMH1			
Test Procedure for an IS200EDGM1 card.							
DOCUMENT REVISION STATUS: Determined by the last entry in the "REV" and "DATE" column							
REV.		DESCRIPTION			SIGNATURE	REV. DATE	
Α	Initial release				R. Johnson	10/2/2012	
В							
С							
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	ARED BY hnson	REVIEWED BY	REVIEWE	D BY	Charlie Wa		
DATE 10/2/2	2012	DATE	DATE		DATE 10/2/2012		

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#### Functional test procedure for an IS200EDGMH1 card tested on the GENRAD® GENEVA system

#### 1. SCOPE

1.1 This is a functional testing procedure for the IS200EDGMH1A circuit boards.

## 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

## 3. APPLICABLE DOCUMENTS

- **3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
  - **3.1.1** Check board's electronic folder for more information.

#### 4. ENGINEERING REQUIREMENTS

- 4.1 Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.
- 4.2 Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - 4.2.1.1 Wires broken or cracked
    - **4.2.1.2** Terminal strips / connectors broken or cracked
    - **4.2.1.3** Loose wires
    - 4.2.1.4 Components visually damaged
    - 4.2.1.5 Capacitors leaking
    - 4.2.1.6 Solder joints damaged or cold
    - 4.2.1.7 Circuit board burned or de-laminated
    - 4.2.1.8 Printed wire runs burned or damaged

#### 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1	H188912	GENRAD Geneva Test System
1	H190034	IS200EDGMH1A Test Fixture

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# 6. Testing Process

- 6.1 Setup
  - **6.1.1** Install fixture H190034 onto Geneva test System.
  - **6.1.2** Install UUT into test fixture.
- **6.2** Testing Procedure
  - **6.2.1** Load appropriate test program and follow instructions on screen.
- 6.3 \*\*\*TEST COMPLETE \*\*\*

#### 7. Notes

7.1 Changes to the electronic GENEVA test are recorded in the following directory;C:\Geneva Info\Geneva, file name is "Geneva Test Fixture Notes".

#### 8. Attachments

**8.1** None at this time.